

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	457	438/458.ccls. and @ad<"20020717"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/15 15:01
L2	687	438/455.ccls. and @ad<"20020717"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/15 15:31
L3	612	438/459.ccls. and @ad<"20020717"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/15 15:18
L4	521	(438/455.ccls. not 438/459.ccls.) and @ad<"20020717"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/15 15:51
L5	272	(438/458.ccls. not (438/459.ccls. or 438/455.ccls.)) and @ad<"20020717"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/15 16:04
L6	217	257/E21.568.ccls. and @ad<"20020717"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/15 16:04
L7	123	(257/E21.568.ccls. not (438/458. ccls. 438/455.ccls. 438/459.ccls.)) and @ad<"20020717"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/15 16:33
L8	1	@pn="6417108"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/15 16:33

S1	7445	(molecular wafer) adj (bond\$3) and @ad<"20020717"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/17 15:03
S4	1065	S1 and sidewall	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/16 10:25
S5	45	S4 and shoulder	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/16 10:13
S6	971	438/455.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/16 13:25
S7	682	S6 and @ad<"20020717"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/16 11:37
S10	611	438/459.ccls. and @ad<"20020717"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/17 12:57
S11	457	438/458.ccls. and @ad<"20020717"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/16 15:18
S15	2	("5152857" "5401670").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/05/17 08:33
S17	300	(molecular wafer) adj (bond\$3) and @ad<"20020717" and (bevel\$3 chamfer\$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/17 12:54

S18	0	(wafer adj bond\$3) and (second\$3 adj chamfer\$3) and @ad<"20020717"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/17 12:55
S20	0	(molecular wafer) adj (bond\$3) and (primary adj chamfer) and @ad<"20020717"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/17 14:47
S21	0	(molecular wafer) adj (bond\$3) and (primary adj bevel) and @ad<"20020717"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/17 14:49
S22	3	BESOI and chamfer	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/17 14:51
S23	3	BESOI and bevel	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/17 14:51
S24	0	(molecular wafer) adj (bond\$3) and @ad<"20020717" and (annual adj chamfer)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/17 15:04
S25	339	@ad<"20020717" and (annular adj chamfer)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/17 15:16
S26	0	@ad<"20020717" and (annular adj chamfer) and ((wafer molecular) adj (bond\$3))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/17 15:05